

Reset Circuit with Manual Reset

Description

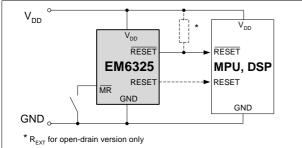
The EM6325 is an ultra-low current reset circuit available in a large variety of configurations and very small packages for maximum flexibility in all end-applications up to 125°C and using power supplies between 1.5V and 5.5V.

This circuit monitors the supply voltage of any electronic system, and generates the appropriate reset signal after a fixed reset timeout period. The threshold defines the minimum allowed voltage which guarantees the good functionality of the system. When V_{DD} rises above V_{TH} , the output remains active for an additional delay time. This allows the system to stabilize before getting fully active.

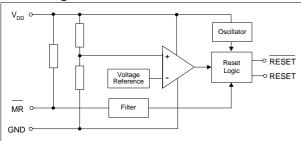
This circuit features a Manual Reset: an input that asserts reset when pulled low (\overline{MR} with internal pull-up).

Small SC70-4L, SC70-5L and SOT23-5L packages as well as ultra-low supply current of 2.9µA make the EM6325 an ideal choice for portable and battery-operated devices.

Typical Application



Block Diagram



Pin Description

Features

- Manual reset function
- 200ms reset timeout period (1.6ms, 25ms, 1600ms on request)
- □ Ultra-low supply current of 2.9µA (V_{DD}=3.3V)
- Operating temperature range: -40°C to +125°C
- □ ±1.5% reset threshold accuracy
- □ 11 reset threshold voltages V_{TH}: 4.63V, 4.4V, 3.08V, 2.93V, 2.63V, 2.2V, 1.8V, 1.66V, 1.57V, 1.38V, 1.31V
- 3 reset output options: Active-low RESET push-pull Active-low RESET open-drain

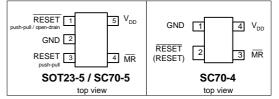
Active-high RESET push-pull

- $\label{eq:limit} \square \quad \text{Immune to short negative } V_{\text{DD}} \, \text{transients}$
- □ Guaranteed Reset valid down to 0.9V
- $\hfill\square$ Threshold hysteresis: 2.1% of V_{TH}
- □ Very small SOT23-5L, SC70-5L and SC70-4L

Applications

- Computers
- Servers and workstations
- Modems
- Wireless communication
- Metering
- Playstations
- D PDA , Webpad
- Automotive systems

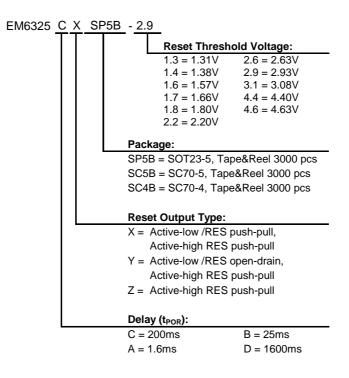
Pin Configuration (top view)



Pin						
SOT23-5L / SC70-5L	SC70-4L	Name	Function			
1	2	RESET	Active-low RESET output. RESET remains low for the reset timeout period and then goes high after all reset conditions are deasserted or after MR goes from low to high			
2	1	GND	Ground			
3	2	RESET	Active-high RESET output. RESET remains high for the reset timeout period and then goes low after all reset conditions are deasserted or after MR goes from low to high			
4	3	MR	Manual Reset input with an internal pull-up $15k\Omega$ resistor. Reset remains active as long as $\overline{\text{MR}}$ is low and for t_{POR} after $\overline{\text{MR}}$ returns high. $\overline{\text{MR}}$ can be driven with a CMOS output or shorted to ground with a switch			
5	4	V _{DD}	Supply Voltage (5.5V max.)			



Ordering Information



Versions

Please contact EM Microelectronic for availability. Please make sure to give the complete Part Number when ordering. All parts are offered in tape-and-reel only (3000 units).

Threshold Voltage	Delay (t _{POR})	Output Type	Package	Part Number	Top Marking
		Active-low push-pull RESET	SOT23-5L	EM6325CXSP5B-1.3	
1.31V	200ms	Active-high push-pull RESET	SC70-5L	EM6325CXSC5B-1.3	ANCA
		Active-low push-pull RESET	SOT23-5L	EM6325CXSP5B-1.8	
1.80V	200ms	Active-high push-pull RESET	SC70-5L	EM6325CXSC5B-1.8	ANCE
		Active-low push-pull RESET	SOT23-5L	EM6325CXSP5B-2.6	
2.63V	200ms	Active-high push-pull RESET	SC70-5L	EM6325CXSC5B-2.6	ANCG
	200ms	Active-low push-pull RESET	SOT23-5L	EM6325CXSP5B-2.9	
		Active-high push-pull RESET	SC70-5L	EM6325CXSC5B-2.9	ANCH
2.93V		Active-low push-pull RESET	SC70-4L	EM6325CXSC4B-2.9	
		Active-low open-drain RESET	SOT23-5L	EM6325CYSP5B-2.9	ANCU
3.08V	200ms	Active-low push-pull RESET	SOT23-5L	EM6325CXSP5B-3.1	ANCJ
	200ms	Active-low push-pull RESET	SOT23-5L	EM6325CXSP5B-4.6	
4.63V		Active-high push-pull RESET	SC70-5L	EM6325CXSC5B-4.6	ANCL
		Active-low open-drain RESET	SOT23-5L	EM6325CYSP5B-4.6	ANCX



Absolute Maximum Ratings

Parameter	Symbol	Conditions		
Voltage at V _{DD} to GND	V _{DD}	-0.3V to +6V		
Minimum voltage at any signal pin	V _{MIN}	GND - 0.3V		
Maximum voltage at any signal pin	V _{MAX}	V _{DD} + 0.3V		
Electrostatic discharge max. to				
MIL-STD-883C method 3015.7	V _{ESD}	2000V		
with ref. to V _{ss}				
Max. soldering conditions	T _{MAX}	250°C x 10s		
Storage Temperature Range	T _{STG}	-65°C to +150°C		

Stresses above these listed maximum ratings may cause permanent damages to the device. Exposure beyond specified operating conditions may affect device reliability or cause malfunction.

Handling Procedures

This device has built-in protection against high static voltages or electric fields; however, anti-static precautions must be taken as for any other CMOS component. Unless otherwise specified, proper operation can only occur when all terminal voltages are kept within the voltage range. Unused inputs must always be tied to a defined logic voltage level.

Operating Conditions

Parameter	Symbol	Min	Max	Unit
Supply voltage	V _{DD}	0.9	5.5	V
Operating Temperature	T _A	-40	+125	°C

Electrical Characteristics

Unless otherwise specified: V_{DD} = 0.9V to 5.5V, T_A =-40°C to +125°C (note 1).

Parameter	Symbol	Conditions		Min	Тур	Max	Unit
Supply current (note 2)	-		+25°C	-		4.6	μA
		$V_{DD}=1.5V$	-40°C to +125°C	-	2.3	7	
		V _{DD} =3.3V	+25°C	-	2.9	5.5	
	I _{DD}		-40°C to +125°C	-		8.3	
		V _{DD} =5.0V	+25°C	-	3.4	6.3	
			-40°C to +125°C	-		9.6	
		EM6325 – 1.3	+25°C	1.290	1.31	1.330	
			-40°C to +85°C	1.245		1.382	
			-40°C to +125°C	1.221		1.387	
			+25°C	1.359		1.401	
		EM6325 – 1.4	-40°C to +85°C	1.311	1.38	1.456	
			-40°C to +125°C	1.286	1	1.461	
			+25°C	1.546		1.594	
		EM6325 – 1.6	-40°C to +85°C	1.492	1.57	1.656	ĺ
			-40°C to +125°C	1.463	ĺ	1.663	
			+25°C	1.635		1.685	
		EM6325 – 1.7	-40°C to +85°C	1.577	1.66	1.751	
			-40°C to +125°C	1.547	1	1.758	
		EM6325 – 1.8	+25°C	1.773	1.80	1.827	
			-40°C to +85°C	1.710		1.899	
			-40°C to +125°C	1.678		1.906	
		EM6325 – 2.2	+25°C	2.167	2.20	2.233	
Threshold voltage	V _{TH}		-40°C to +85°C	2.090		2.321	
(note 3)			-40°C to +125°C	2.050		2.330	
		EM6325 – 2.6	+25°C	2.591	2.63	2.669	
			-40°C to +85°C	2.499		2.775	
			-40°C to +125°C	2.451		2.785	
		EM6325 – 2.9	+25°C	2.886		2.974	
			-40°C to +85°C	2.784	2.93	3.091	
			-40°C to +125°C	2.731		3.103	
			+25°C	3.034		3.126	
		EM6325 – 3.1	-40°C to +85°C	2.926	3.08	3.249	•
			-40°C to +125°C	2.871		3.262	
			+25°C	4.334		4.466	1
		EM6325 - 4.4	-40°C to +85°C	4.180	4.40	4.642	
			-40°C to +125°C	4.101		4.660	
		EM6325 – 4.6	+25°C	4.561		4.699	
			-40°C to +85°C	4.399	4.63	4.885	
			-40°C to +125°C	4.315		4.903	
		T _A =+25°C					

Note 1: Production tested at +25°C only. Over temperature limits are guaranteed by design, not production tested. **Note 3:** Threshold voltage is specified for V_{DD} falling.



Electrical Characteristics (continued)

Parameter	Symbol	Conditions			Min	Тур	Max	Unit	
		(note 2 and 4) V_{DD} from 0V to $V_{TH (typ)}$ +15% T_A = +25°C EM6325B		EM6325C	155	200	224	- ms	
Reset timeout period				EM6325A	0.7	1.6	3.8		
Reset timeout penou	t _{POR}			EM6325B	19.4	25	28		
				EM6325D	1240	1600	1792		
Propagation delay time V_{DD} to RESET (RESET) delay	t _P	V_{DD} drops from $V_{\text{TH (typ)}}\text{+}0.2V$ to $V_{\text{TH (typ)}}\text{-}0.2V$ (note 2). $T_{\text{A}}\text{=}\text{+}25^{\circ}\text{C}$		2	130	255	μs		
		V _{DD} >1V	I _{OL} =100μA	μΑ Ο		0.3			
Open-drain RESET output	V _{OL}	V _{DD} >2.5V	I _{OL} =1.5mA		-	-	0.3	V	
Voltage		V _{DD} >5V	I _{OL} =3mA		-	-	0.35		
	V _{OL}	V _{DD} >1V	I _{OL} =100μA		-	-	0.3	3	
		V _{DD} >2.5V	I _{OL} =1.5mA I _{OL} =3mA		-	-	0.3	- V	
Push-pull RESET / RESET		V _{DD} >5V			-	-	0.35		
Output voltage	V _{OH}	V _{DD} >1V	I _{OH} =-30μA		0.8	-	-		
		V _{DD} >2.5V	I _{OH} =-1.5mA 2 -		-				
		V _{DD} >5V	I _{OH} =-3mA		4	-	-		
Output leakage current	I _{LEAK}	Only for EM6325_Y (open-drain)		-	-	0.5	μA		
MANUAL RESET (MR)									
MR Input low	V_{MRT} low					0.3•V _{DD}	V		
MR Input high	V_{MRT} high			0.7•V _{DD}			V		
MR to Reset delay	t _{MD}				0.3		μS		
Pulse width at \overline{MR} (note 5)	t _{PMD}			1			μS		
MR Internal Pull-up resistor	R _{MR}	T _A =-40°C to +125°C			4.8	15	31	kΩ	

Unless otherwise specified: V_{DD} = 0.9V to 5.5V, T_A =-40°C to +125° C (note 1).

Note 1: Production tested at +25°C only. Over temperature limits are guaranteed by design, not production tested.

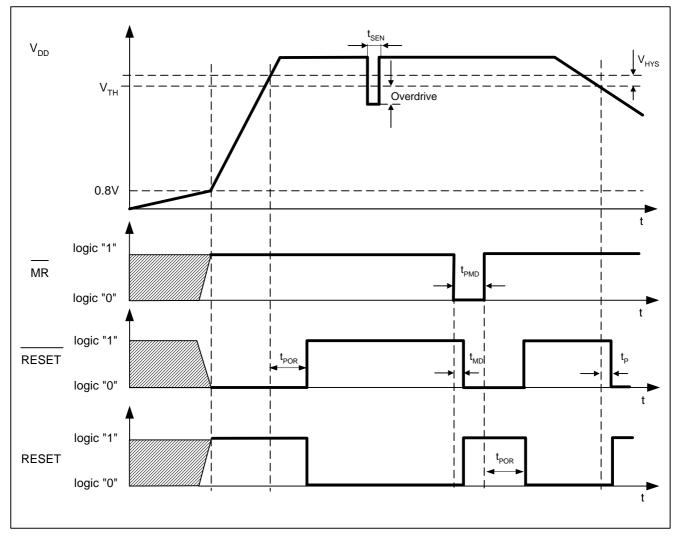
Note 2: RESET (RESET) open.

Note 4: Standard version for t_{POR} is 200ms (typ), available at all times. Other option (1.6ms, 25ms, 1600ms) are available by mask option and upon minimum order quantity. Please contact EM sales.

Note 5: Pulse width must be greater than 1μ s to ensure the RESET (RESET) to go active.



Timing Waveforms



Note 6: t_{SEN} = Maximum Transient Duration. Please refer to figure on the next page. **Note 7:** Overdrive = V_{TH} -V_{DD}. Please refer to figure on the next page.

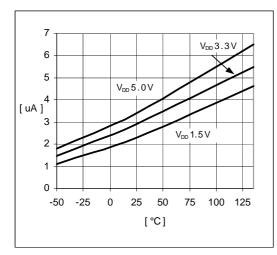
Manual Reset Input

A logic low on $\overline{\text{MR}}$ asserts a reset. Reset remains asserted while $\overline{\text{MR}}$ is low, and for t_{POR} (200ms nominal for EM6325C) after it returns high. $\overline{\text{MR}}$ has an internal 15k Ω pull-up resistor, so it can be left open if unused. This input can be driven with CMOS logic levels or with open-drain outputs. Connect a normally open momentary switch from $\overline{\text{MR}}$ to V_{SS} to create a manual-reset function; debounce circuitry is integrated. If $\overline{\text{MR}}$ is driven from long cable or the device is used in a noisy environment, connect a 0.1µF capacitor from $\overline{\text{MR}}$ to V_{SS} to provide additional noise immunity (stronger external additional pull-up resistor can also be added).

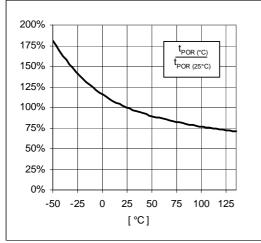


Typical Operating Characteristics

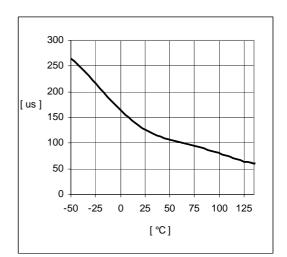
(Typical values are at T_A=+25°C unless otherwise noted, \overline{MR} , \overline{RESET} and RESET open.)



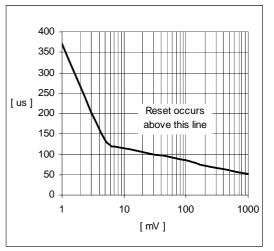
IDD vs. Temperature



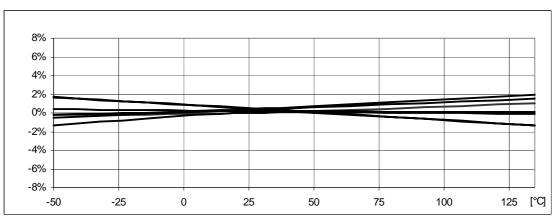
Reset Timeout Period t_{POR} vs. Temperature (normalized with respect to t_{POR 25°C})



Propagation Time t_P vs. Temperature



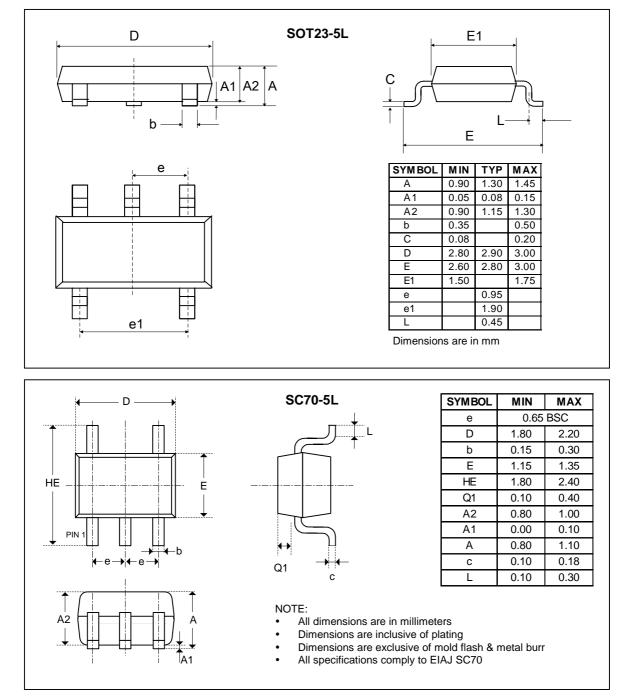
Maximum Transient Duration t_{SEN} vs. Overdrive V_{TH}-V_{DD}



Threshold Voltage Variation vs. Temperature (normalized)

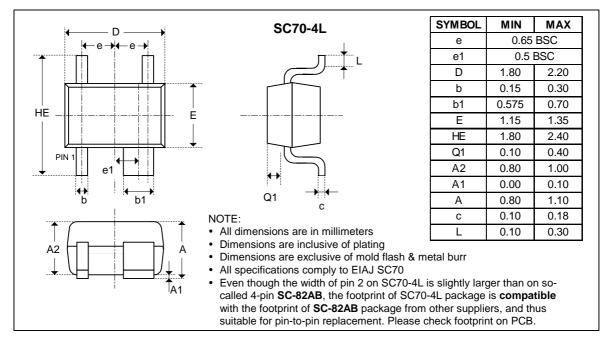


Package Information





EM6325



Traceability for small packages

Due to the limited space on the package surface, the bottom marking contains a limited number of characters that provide only partial information for lot traceability. Full information for complete traceability is however provided on the packing labels of the product at delivery from EM. It is highly recommended that the customer insures full lot traceability of EM product in his final product.

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Product qualification is performed according to internal EM quality standards for industrial products. For any special requirement (eg. automotive grade) please contact EM Microelectronic-Marin S.A.

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